Multilayer Ceramic Chip Capacitors

CGA3E2X7R1H102M080AA



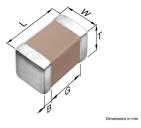






TDK item description CGA3E2X7R1H102MT****

Applications	Automotive Grade	
Feature	General General (Up to 50V) AEC-Q200 AEC-Q200	
Series	CGA3(1608) [EIA 0603]	
Status	Production	



Size		
Length(L)	1.60mm ±0.10mm	
Width(W)	0.80mm ±0.10mm	
Thickness(T)	0.80mm ±0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)	
recommended Land Fattern (FA)	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)	
Recommended Land Fattern (FB)	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)	
neconiniente Land Fattern (FC)	0.60mm to 0.80mm(Reflow Soldering)	

Electrical Characteristics		
Capacitance	1nF ±20%	
Rated Voltage	50VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Wave (Flow)
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.



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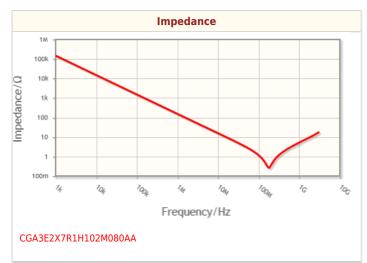


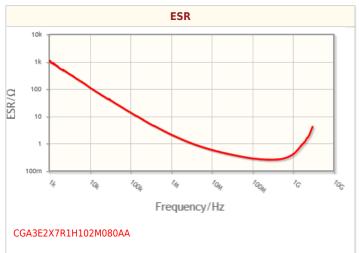


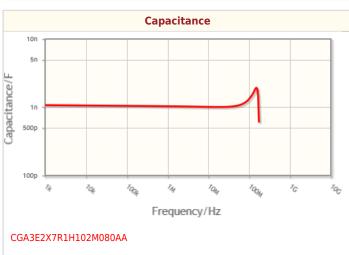


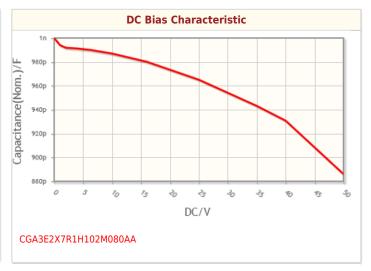


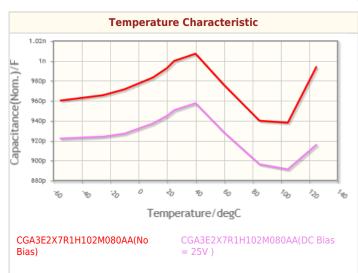
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

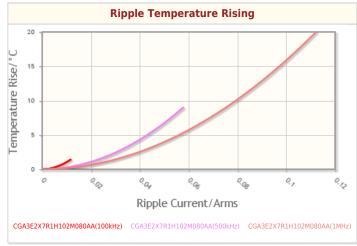












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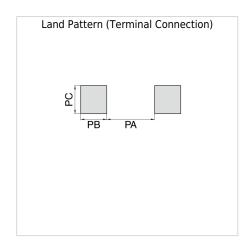








Associated Images



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